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PIC18(L)F2X/4XK22

28/40/44-Pin, Low-Power, High-Performance Microcontrollers with XLP Technology

High-Performance RISC CPU:

- C Compiler Optimized Architecture:
  - Optional extended instruction set designed to optimize re-entrant code
- Up to 1024 Bytes Data EEPROM
- Up to 64 Kbytes Linear Program Memory Addressing
- Up to 3896 Bytes Linear Data Memory Addressing
- Up to 16 MIPS Operation
- 16-bit Wide Instructions, 8-bit Wide Data Path
- Priority Levels for Interrupts
- 31-Level, Software Accessible Hardware Stack
- 8 x 8 Single-Cycle Hardware Multiplier

Flexible Oscillator Structure:

- Precision 16 MHz Internal Oscillator Block:
  - Factory calibrated to ± 1%
  - Selectable frequencies, 31 kHz to 16 MHz
  - 64 MHz performance available using PLL – no external components required
- Four Crystal modes up to 64 MHz
- Two External Clock modes up to 64 MHz
- 4X Phase Lock Loop (PLL)
- Secondary Oscillator using Timer1 @ 32 kHz
- Fail-Safe Clock Monitor:
  - Allows for safe shutdown if peripheral clock stops
  - Two-Speed Oscillator Start-up

Analog Features:

- Analog-to-Digital Converter (ADC) module:
  - 10-bit resolution, up to 30 external channels
  - Auto-acquisition capability
  - Conversion available during Sleep
  - Fixed Voltage Reference (FVR) channel
  - Independent input multiplexing
- Analog Comparator module:
  - Two rail-to-rail analog comparators
  - Independent input multiplexing
- Digital-to-Analog Converter (DAC) module:
  - Fixed Voltage Reference (FVR) with 1.024V, 2.048V and 4.096V output levels
  - 5-bit rail-to-rail resistive DAC with positive and negative reference selection
- Charge Time Measurement Unit (CTMU) module:
  - Supports capacitive touch sensing for touch screens and capacitive switches

eXtreme Low-Power Features (XLP) (PIC18(L)F2X/4XK22):

- Sleep mode: 20 nA, typical
- Watchdog Timer: 300 nA, typical
- Timer1 Oscillator: 800 nA @ 32 kHz
- Peripheral Module Disable

Special Microcontroller Features:

- 2.3V to 5.5V Operation – PIC18FXXK22 devices
- 1.8V to 3.6V Operation – PIC18LFXXK22 devices
- Self-Programmable under Software Control
- High/Low-Voltage Detection (HLVD) module:
  - Programmable 16-Level
  - Interrupt on High/Low-Voltage Detection
- Programmable Brown-out Reset (BOR):
  - With software enable option
  - Configurable shutdown in Sleep
- Extended Watchdog Timer (WDT):
  - Programmable period from 4 ms to 131s
- In-Circuit Serial Programming™ (ICSP™):
  - Single-Supply 3V
- In-Circuit Debug (ICD)

Peripheral Highlights:

- Up to 35 I/O Pins plus 1 Input-Only Pin:
  - High-Current Sink/Source 25 mA/25 mA
  - Three programmable external interrupts
  - Four programmable interrupt-on-change
  - Nine programmable weak pull-ups
  - Programmable slew rate
- SR Latch:
  - Multiple Set/Reset input options
- Two Capture/Compare/PWM (CCP) modules
- Three Enhanced CCP (ECCP) modules:
  - One, two or four PWM outputs
  - Selectable polarity
  - Programmable dead time
  - Auto-Shutdown and Auto-Restart
  - PWM steering
- Two Master Synchronous Serial Port (MSSP) modules:
  - 3-wire SPI (supports all 4 modes)
  - I^2C Master and Slave modes with address mask

- Two Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART) modules:
  - Supports RS-485, RS-232 and LIN
  - RS-232 operation using internal oscillator
  - Auto-Wake-up on Break
  - Auto-Baud Detect

TABLE 1: PIC18(L)F2X/4XK22 FAMILY TYPES

Device	Program Memory		Data Memory		I/O(1)	10-bit A/D Channels(2)	CCP	ECCP (Full-Bridge)	ECCP (Half-Bridge)	MSSP		EUSART	Comparator	CTMU	BOR/LVD	SR Latch	8-bit Timer	16-bit Timer
	Flash (Bytes)	# Single-Word Instructions	SRAM (Bytes)	EEPROM (Bytes)						SPI	I^2C							
PIC18(L)F23K22	8K	4096	512	256	25	19	2	1	2	2	2	2	2	Y	Y	Y	3	4
PIC18(L)F24K22	16K	8192	768	256	25	19	2	1	2	2	2	2	2	Y	Y	Y	3	4
PIC18(L)F25K22	32K	16384	1536	256	25	19	2	1	2	2	2	2	2	Y	Y	Y	3	4
PIC18(L)F26K22	64k	32768	3896	1024	25	19	2	1	2	2	2	2	2	Y	Y	Y	3	4
PIC18(L)F43K22	8K	4096	512	256	36	30	2	2	1	2	2	2	2	Y	Y	Y	3	4
PIC18(L)F44K22	16K	8192	768	256	36	30	2	2	1	2	2	2	2	Y	Y	Y	3	4
PIC18(L)F45K22	32K	16384	1536	256	36	30	2	2	1	2	2	2	2	Y	Y	Y	3	4
PIC18(L)F46K22	64k	32768	3896	1024	36	30	2	2	1	2	2	2	2	Y	Y	Y	3	4

Note 1: One pin is input only.

2: Channel count includes internal FVR and DAC channels.

FIGURE 1: 28-PIN PDIP, SOIC, SSOP DIAGRAM

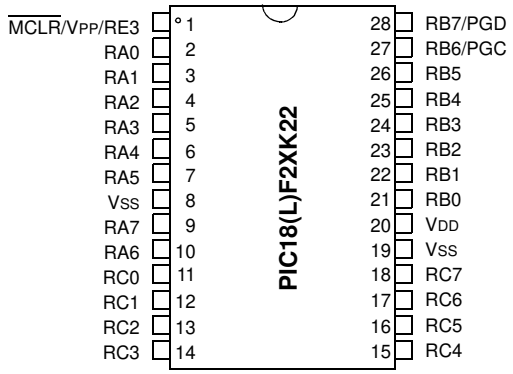
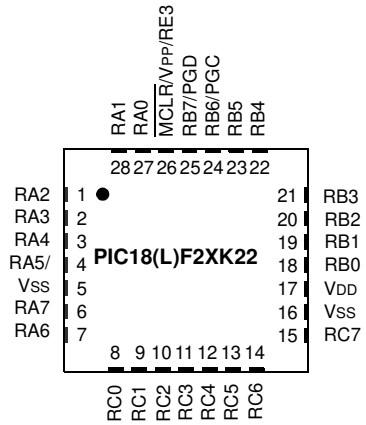


FIGURE 2: 28-PIN QFN, UQFN(1) DIAGRAM



Note 1: The 28-pin UQFN package is available only for PIC18(L)F23K22 and PIC18(L)F24K22.

FIGURE 3: 40-PIN PDIP DIAGRAM

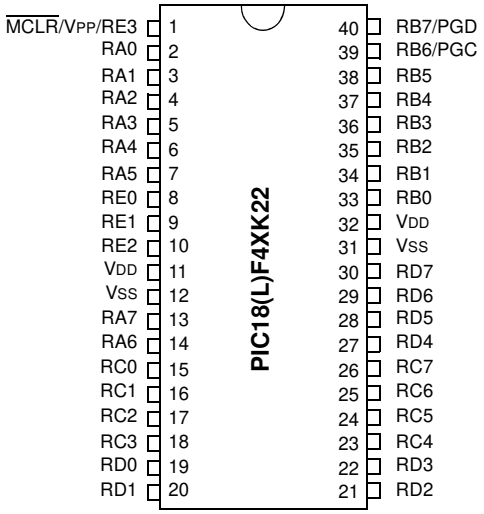


FIGURE 4: 40-PIN UQFN DIAGRAM

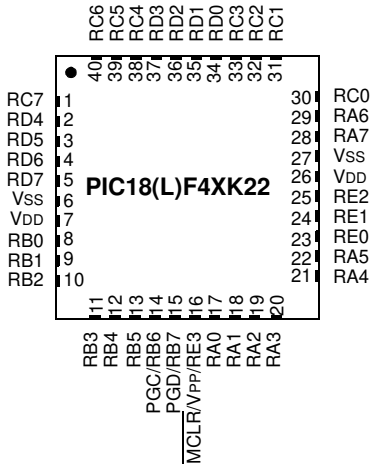


FIGURE 5: 44-PIN TQFP DIAGRAM

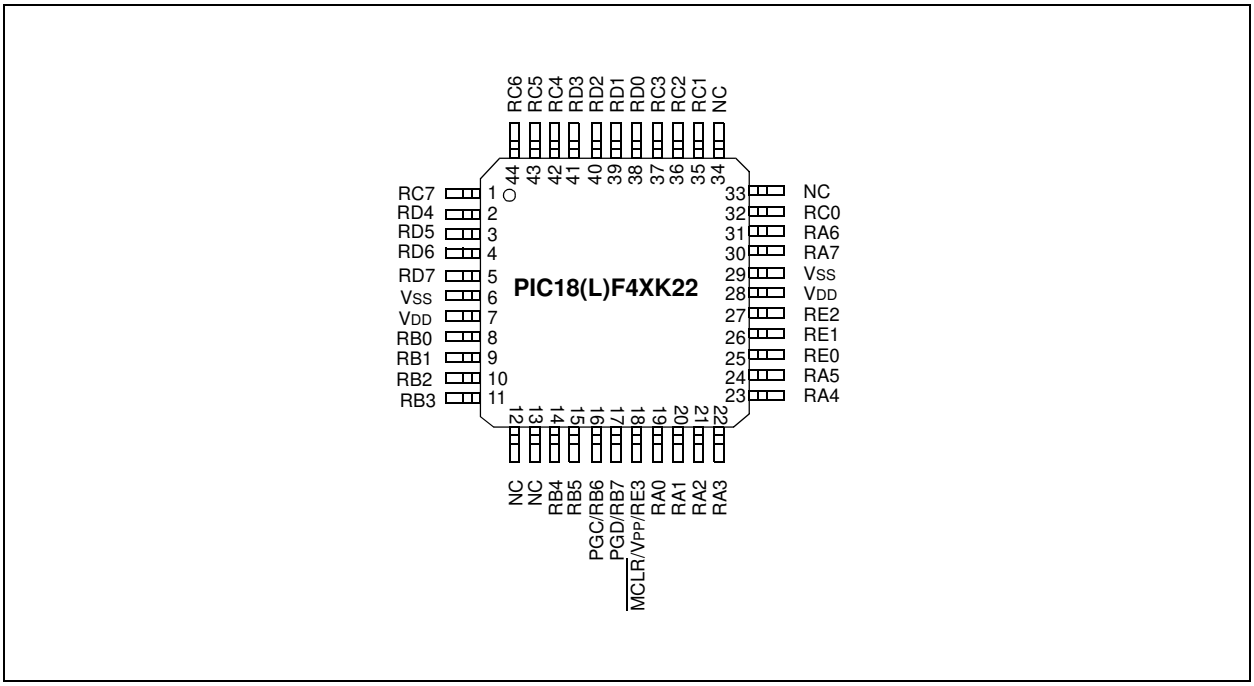


FIGURE 6: 44-PIN QFN DIAGRAM

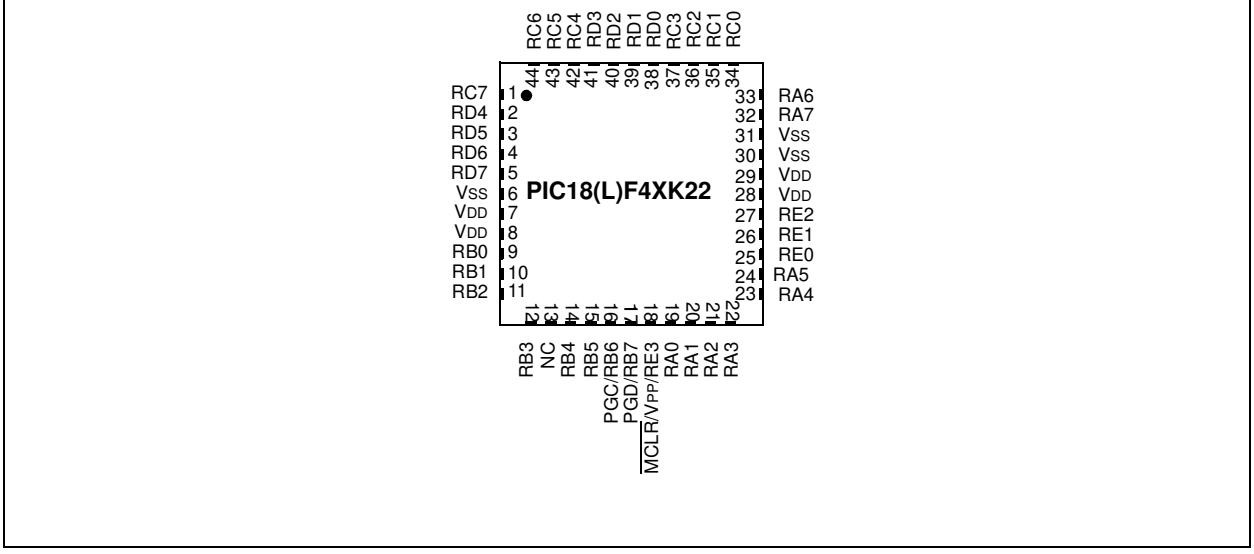


TABLE 2: PIC18(L)F2XK22 PIN SUMMARY

28-SSOP, SOIC 28-SPDIP	28-QFN, UQFN	I/O	Analog	Comparator	CTMU	SR Latch	Reference	(E)CCP	EUSART	MSSP	Timers	Interrupts	Pull-up	Basic
2	27	RA0	AN0	C12IN0-										
3	28	RA1	AN1	C12IN1-										
4	1	RA2	AN2	C2IN+			VREF- DACOUT							
5	2	RA3	AN3	C1IN+			VREF+							
6	3	RA4		C1OUT		SRQ		CCP5			T0CKI			
7	4	RA5	AN4	C2OUT		SRNQ	HLVDIN			$\overline{SS}$1				
10	7	RA6												OSC2 CLKO
9	6	RA7												OSC1 CLKI
21	18	RB0	AN12			SRI		CCP4 FLT0		$\overline{SS}$2		INT0	Y	
22	19	RB1	AN10	C12IN3-				P1C		SCK2 SCL2		INT1	Y	
23	20	RB2	AN8		CTED1			P1B		SDI2 SDA2		INT2	Y	
24	21	RB3	AN9	C12IN2-	CTED2			CCP2 P2A(1)		SDO2			Y	
25	22	RB4	AN11					P1D			T5G	IOC	Y	
26	23	RB5	AN13					CCP3 P3A(4) P2B(3)			T1G T3CKI(2)	IOC	Y	
27	24	RB6							TX2/CK2			IOC	Y	PGC
28	25	RB7							RX2/DT2			IOC	Y	PGD
11	8	RC0						P2B(3)			SOSCO T1CKI T3CKI(2) T3G			
12	9	RC1						CCP2 P2A(1)			SOSCI			
13	10	RC2	AN14		CTPLS			CCP1 P1A			T5CKI			
14	11	RC3	AN15							SCK1 SCL1				
15	12	RC4	AN16							SDI1 SDA1				
16	13	RC5	AN17							SDO1				
17	14	RC6	AN18					CCP3 P3A(4)	TX1/CK1					
18	15	RC7	AN19					P3B	RX1/DT1					
1	26	RE3												$\overline{MCLR}$ VPP
8, 19 19	5, 16 16	VSS												VSS
20	17	VDD												VDD

Note 1: CCP2/P2A multiplexed in fuses.
2: T3CKI multiplexed in fuses.
3: P2B multiplexed in fuses.
4: CCP3/P3A multiplexed in fuses.

TABLE 3: PIC18(L)F4XK22 PIN SUMMARY

40-PDIP	40-UQFN	44-TQFP	44-QFN	I/O	Analog	Comparator	CTMU	SR Latch	Reference	(E)CCP	EUSART	MSSP	Timers	Interrupts	Pull-up	Basic
2	17	19	19	RA0	AN0	C12IN0-										
3	18	20	20	RA1	AN1	C12IN1-										
4	19	21	21	RA2	AN2	C2IN+			VREF- DACOUT							
5	20	22	22	RA3	AN3	C1IN+			VREF+							
6	21	23	23	RA4		C1OUT		SRQ					T0CKI			
7	22	24	24	RA5	AN4	C2OUT		SRNQ	HLVDIN			$\overline{SS}$1				
14	29	31	33	RA6												OSC2 CLKO
13	28	30	32	RA7												OSC1 CLKI
33	8	8	9	RB0	AN12			SRI		FLT0				INT0	Y	
34	9	9	10	RB1	AN10	C12IN3-								INT1	Y	
35	10	10	11	RB2	AN8		CTED1							INT2	Y	
36	11	11	12	RB3	AN9	C12IN2-	CTED2			CCP2 P2A(1)					Y	
37	12	14	14	RB4	AN11								T5G	IOC	Y	
38	13	15	15	RB5	AN13					CCP3 P3A(3)			T1G T3CKI(2)	IOC	Y	
39	14	16	16	RB6										IOC	Y	PGC
40	15	17	17	RB7										IOC	Y	PGD
15	30	32	34	RC0						P2B(4)			SOSCO T1CKI T3CKI(2) T3G			
16	31	35	35	RC1						CCP2(1) P2A			SOSCI			
17	32	36	36	RC2	AN14		CTPLS			CCP1 P1A			T5CKI			
18	33	37	37	RC3	AN15							SCK1 SCL1				
23	38	42	42	RC4	AN16							SDI1 SDA1				
24	39	43	43	RC5	AN17							SDO1				
25	40	44	44	RC6	AN18						TX1 CK1					
26	1	1	1	RC7	AN19						RX1 DT1					
19	34	38	38	RD0	AN20							SCK2 SCL2				
20	35	39	39	RD1	AN21					CCP4		SDI2 SDA2				
21	36	40	40	RD2	AN22					P2B(4)						
22	37	41	41	RD3	AN23					P2C		$\overline{SS}$2				
27	2	2	2	RD4	AN24					P2D		SD02				
28	3	3	3	RD5	AN25					P1B						
29	4	4	4	RD6	AN26					P1C	TX2 CK2					
30	5	5	5	RD7	AN27					P1D	RX2 DT2					
8	23	25	25	RE0	AN5					CCP3 P3A(3)						

Note 1: CCP2 multiplexed in fuses.
2: T3CKI multiplexed in fuses.
3: CCP3/P3A multiplexed in fuses.
4: P2B multiplexed in fuses.

TABLE 3: PIC18(L)F4XK22 PIN SUMMARY (CONTINUED)

40-PDIP	40-UQFN	44-TQFP	44-QFN	I/O	Analog	Comparator	CTMU	SR Latch	Reference	(E)CCP	EUSART	MSSP	Timers	Interrupts	Pull-up	Basic
9	24	26	26	RE1	AN6					P3B						
10	25	27	27	RE2	AN7					CCP5						
1	16	18	18	RE3											Y	$\overline{MCLR}$ V_{PP}
11, 32	7, 26	7, 28	7,8 28, 29	V_{DD}												V_{DD}
12, 31	6, 27	6, 29	6, 30, 31	V_{SS}												V_{SS}
—	—	12, 13 33, 34	13	NC												

Note 1: CCP2 multiplexed in fuses.
2: T3CKI multiplexed in fuses.
3: CCP3/P3A multiplexed in fuses.
4: P2B multiplexed in fuses.

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1.0 DEVICE OVERVIEW

This document contains device specific information for the following devices:

- PIC18F23K22
- PIC18F24K22
- PIC18F25K22
- PIC18F26K22
- PIC18F43K22
- PIC18F44K22
- PIC18F45K22
- PIC18F46K22
- PIC18LF23K22
- PIC18LF24K22
- PIC18LF25K22
- PIC18LF26K22
- PIC18LF43K22
- PIC18LF44K22
- PIC18LF45K22
- PIC18LF46K22

This family offers the advantages of all PIC18 microcontrollers – namely, high computational performance at an economical price – with the addition of high-endurance, Flash program memory. On top of these features, the PIC18(L)F2X/4XK22 family introduces design enhancements that make these microcontrollers a logical choice for many high-performance, power sensitive applications.

1.1 New Core Features

1.1.1 XLP TECHNOLOGY

All of the devices in the PIC18(L)F2X/4XK22 family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- **Alternate Run Modes:** By clocking the controller from the Timer1 source or the internal oscillator block, power consumption during code execution can be reduced by as much as 90%.
- **Multiple Idle Modes:** The controller can also run with its CPU core disabled but the peripherals still active. In these states, power consumption can be reduced even further, to as little as 4% of normal operation requirements.
- **On-the-fly Mode Switching:** The power-managed modes are invoked by user code during operation, allowing the user to incorporate power-saving ideas into their application's software design.
- **Low Consumption in Key Modules:** The power requirements for both Timer1 and the Watchdog Timer are minimized. See **Section 27.0 "Electrical Specifications"** for values.

1.1.2 MULTIPLE OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC18(L)F2X/4XK22 family offer ten different oscillator options, allowing users a wide range of choices in developing application hardware. These include:

- Four Crystal modes, using crystals or ceramic resonators
- Two External Clock modes, offering the option of using two pins (oscillator input and a divide-by-4 clock output) or one pin (oscillator input, with the second pin reassigned as general I/O)
- Two External RC Oscillator modes with the same pin options as the External Clock modes
- An internal oscillator block which contains a 16 MHz HFINTOSC oscillator and a 31 kHz LFINTOSC oscillator, which together provide eight user selectable clock frequencies, from 31 kHz to 16 MHz. This option frees the two oscillator pins for use as additional general purpose I/O.
- A Phase Lock Loop (PLL) frequency multiplier, available to both external and internal oscillator modes, which allows clock speeds of up to 64 MHz. Used with the internal oscillator, the PLL gives users a complete selection of clock speeds, from 31 kHz to 64 MHz – all without using an external crystal or clock circuit.

Besides its availability as a clock source, the internal oscillator block provides a stable reference source that gives the family additional features for robust operation:

- **Fail-Safe Clock Monitor:** This option constantly monitors the main clock source against a reference signal provided by the LFINTOSC. If a clock failure occurs, the controller is switched to the internal oscillator block, allowing for continued operation or a safe application shutdown.
- **Two-Speed Start-up:** This option allows the internal oscillator to serve as the clock source from Power-on Reset, or Wake-up from Sleep mode, until the primary clock source is available.

1.2 Other Special Features

- **Memory Endurance:** The Flash cells for both program memory and data EEPROM are rated to last for many thousands of erase/write cycles – up to 10K for program memory and 100K for EEPROM. Data retention without refresh is conservatively estimated to be greater than 40 years.
- **Self-programmability:** These devices can write to their own program memory spaces under internal software control. By using a bootloader routine located in the protected Boot Block at the top of program memory, it becomes possible to create an application that can update itself in the field.
- **Extended Instruction Set:** The PIC18(L)F2X/4XK22 family introduces an optional extension to the PIC18 instruction set, which adds eight new instructions and an Indexed Addressing mode. This extension, enabled as a device configuration option, has been specifically designed to optimize re-entrant application code originally developed in high-level languages, such as C.
- **Enhanced CCP module:** In PWM mode, this module provides one, two or four modulated outputs for controlling half-bridge and full-bridge drivers. Other features include:
  - Auto-Shutdown, for disabling PWM outputs on interrupt or other select conditions
  - Auto-Restart, to reactivate outputs once the condition has cleared
  - Output steering to selectively enable one or more of four outputs to provide the PWM signal.
- **Enhanced Addressable EUSART:** This serial communication module is capable of standard RS-232 operation and provides support for the LIN bus protocol. Other enhancements include automatic baud rate detection and a 16-bit Baud Rate Generator for improved resolution. When the microcontroller is using the internal oscillator block, the EUSART provides stable operation for applications that talk to the outside world without using an external crystal (or its accompanying power requirement).
- **10-bit A/D Converter:** This module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period and thus, reduce code overhead.
- **Extended Watchdog Timer (WDT):** This enhanced version incorporates a 16-bit postscaler, allowing an extended time-out range that is stable across operating voltage and temperature. See **Section 27.0 "Electrical Specifications"** for time-out periods.
- **Charge Time Measurement Unit (CTMU)**
- **SR Latch Output:**

1.3 Details on Individual Family Members

Devices in the PIC18(L)F2X/4XK22 family are available in 28-pin and 40/44-pin packages. The block diagram for the device family is shown in Figure 1-1.

The devices have the following differences:

1. Flash program memory
2. Data Memory SRAM
3. Data Memory EEPROM
4. A/D channels
5. I/O ports
6. ECCP modules (Full/Half Bridge)
7. Input Voltage Range/Power Consumption

All other features for devices in this family are identical. These are summarized in Table 1-1.

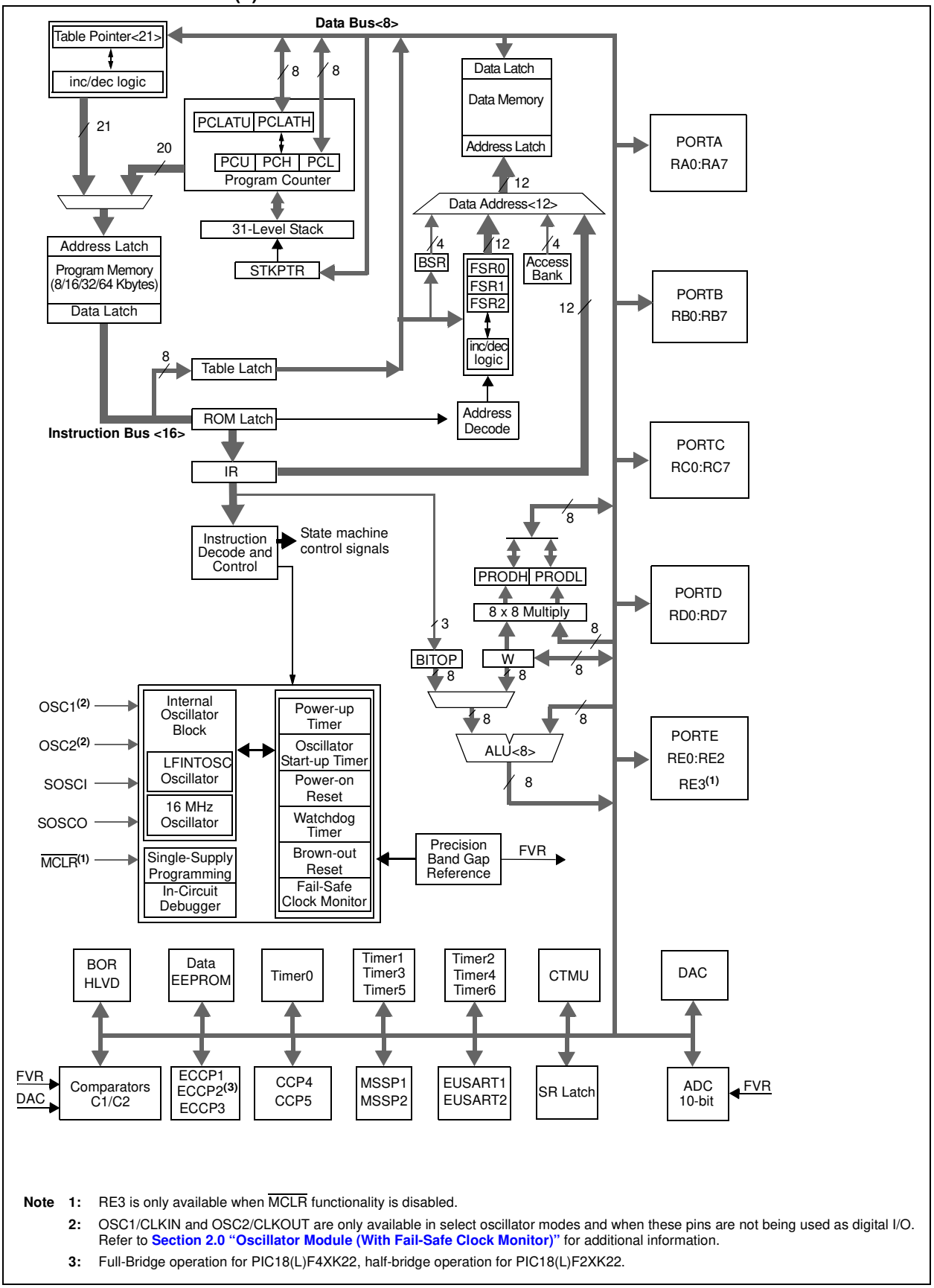
The pinouts for all devices are listed in the pin summary tables: Table 2 and Table 3, and I/O description tables: Table 1-2 and Table 1-3.

TABLE 1-1: DEVICE FEATURES

Features	PIC18F23K22 PIC18LF23K22	PIC18F24K22 PIC18LF24K22	PIC18F25K22 PIC18(L)F25K22	PIC18F26K22 PIC18LF26K22	PIC18F43K22 PIC18LF43K22	PIC18F44K22 PIC18LF44K22	PIC18F45K22 PIC18LF45K22	PIC18F46K22 PIC18LF46K22
Program Memory (Bytes)	8192	16384	32768	65536	8192	16384	32768	65536
Program Memory (Instructions)	4096	8192	16384	32768	4096	8192	16384	32768
Data Memory (Bytes)	512	768	1536	3896	512	768	1536	3896
Data EEPROM Memory (Bytes)	256	256	256	1024	256	256	256	1024
I/O Ports	A, B, C, E(1)	A, B, C, E(1)	A, B, C, E(1)	A, B, C, E(1)	A, B, C, D, E	A, B, C, D, E	A, B, C, D, E	A, B, C, D, E
Capture/Compare/PWM Modules (CCP)	2	2	2	2	2	2	2	2
Enhanced CCP Modules (ECCP) - Half Bridge	2	2	2	2	1	1	1	1
Enhanced CCP Modules (ECCP) - Full Bridge	1	1	1	1	2	2	2	2
10-bit Analog-to-Digital Module (ADC)	2 internal 17 input	2 internal 17 input	2 internal 17 input	2 internal 17 input	2 internal 28 input	2 internal 28 input	2 internal 28 input	2 internal 28 input
Packages	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN 28-pin UQFN	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN 28-pin UQFN	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	28-pin PDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	40-pin PDIP 40-pin UQFN 44-pin QFN 44-pin TQFP	40-pin PDIP 40-pin UQFN 44-pin QFN 44-pin TQFP	40-pin PDIP 40-pin UQFN 44-pin QFN 44-pin TQFP	40-pin PDIP 40-pin UQFN 44-pin QFN 44-pin TQFP
Interrupt Sources	33							
Timers (16-bit)	4							
Serial Communications	2 MSSP, 2 EUSART							
SR Latch	Yes							
Charge Time Measurement Unit Module (CTMU)	Yes							
Programmable High/Low-Voltage Detect (HLVD)	Yes							
Programmable Brown-out Reset (BOR)	Yes							
Resets (and Delays)	POR, BOR, RESET Instruction, Stack Overflow, Stack Underflow (PWRT, OST), MCLR, WDT							
Instruction Set	75 Instructions; 83 with Extended Instruction Set enabled							
Operating Frequency	DC - 64 MHz							

Note 1: PORTE contains the single RE3 read-only bit.

FIGURE 1-1: PIC18(L)F2X/4XK22 FAMILY BLOCK DIAGRAM



Note 1: RE3 is only available when $\overline{\text{MCLR}}$ functionality is disabled.

2: OSC1/CLKIN and OSC2/CLKOUT are only available in select oscillator modes and when these pins are not being used as digital I/O. Refer to **Section 2.0 "Oscillator Module (With Fail-Safe Clock Monitor)"** for additional information.

3: Full-Bridge operation for PIC18(L)F4XK22, half-bridge operation for PIC18(L)F2XK22.

TABLE 1-2: PIC18(L)F2XK22 PINOUT I/O DESCRIPTIONS

Pin Number		Pin Name	Pin Type	Buffer Type	Description
PDIP, SOIC	QFN, UQFN				
2	27	RA0/C12IN0-/AN0			
		RA0	I/O	TTL	Digital I/O.
		C12IN0-	I	Analog	Comparators C1 and C2 inverting input.
		AN0	I	Analog	Analog input 0.
3	28	RA1/C12IN1-/AN1			
		RA1	I/O	TTL	Digital I/O.
		C12IN1-	I	Analog	Comparators C1 and C2 inverting input.
		AN1	I	Analog	Analog input 1.
4	1	RA2/C2IN+/AN2/DACOUT/VREF-			
		RA2	I/O	TTL	Digital I/O.
		C2IN+	I	Analog	Comparator C2 non-inverting input.
		AN2	I	Analog	Analog input 2.
		DACOUT	O	Analog	DAC Reference output.
		VREF-	I	Analog	A/D reference voltage (low) input.
5	2	RA3/C1IN+/AN3/VREF+			
		RA3	I/O	TTL	Digital I/O.
		C1IN+	I	Analog	Comparator C1 non-inverting input.
		AN3	I	Analog	Analog input 3.
		VREF+	I	Analog	A/D reference voltage (high) input.
6	3	RA4/CCP5/C1OUT/SRQ/T0CKI			
		RA4	I/O	ST	Digital I/O.
		CCP5	I/O	ST	Capture 5 input/Compare 5 output/PWM 5 output.
		C1OUT	O	CMOS	Comparator C1 output.
		SRQ	O	TTL	SR latch Q output.
		T0CKI	I	ST	Timer0 external clock input.
7	4	RA5/C2OUT/SRNQ/$\overline{SS1}$/HLVDIN/AN4			
		RA5	I/O	TTL	Digital I/O.
		C2OUT	O	CMOS	Comparator C2 output.
		SRNQ	O	TTL	SR latch $\overline{Q}$ output.
		$\overline{SS1}$	I	TTL	SPI slave select input (MSSP).
		HLVDIN	I	Analog	High/Low-Voltage Detect input.
		AN4	I	Analog	Analog input 4.
10	7	RA6/CLKO/OSC2			
		RA6	I/O	TTL	Digital I/O.
		CLKO	O		In RC mode, OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
		OSC2	O		Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-2: PIC18(L)F2XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Number		Pin Name	Pin Type	Buffer Type	Description
PDIP, SOIC	QFN, UQFN				
9	6	RA7/CLKI/OSC1			
		RA7	I/O	TTL	Digital I/O.
		CLKI	I	CMOS	External clock source input. Always associated with pin function OSC1.
		OSC1	I	ST	Oscillator crystal input or external clock source input ST buffer when configured in RC mode; CMOS otherwise.
21	18	RB0/INT0/CCP4/FLT0/SRI/$\overline{SS2}$/AN12			
		RB0	I/O	TTL	Digital I/O.
		INT0	I	ST	External interrupt 0.
		CCP4	I/O	ST	Capture 4 input/Compare 4 output/PWM 4 output.
		FLT0	I	ST	PWM Fault input for ECCP Auto-Shutdown.
		SRI	I	ST	SR latch input.
		$\overline{SS2}$	I	TTL	SPI slave select input (MSSP).
		AN12	I	Analog	Analog input 12.
22	19	RB1/INT1/P1C/SCK2/SCL2/C12IN3-/AN10			
		RB1	I/O	TTL	Digital I/O.
		INT1	I	ST	External interrupt 1.
		P1C	O	CMOS	Enhanced CCP1 PWM output.
		SCK2	I/O	ST	Synchronous serial clock input/output for SPI mode (MSSP).
		SCL2	I/O	ST	Synchronous serial clock input/output for I^2C mode (MSSP).
		C12IN3-	I	Analog	Comparators C1 and C2 inverting input.
		AN10	I	Analog	Analog input 10.
23	20	RB2/INT2/CTED1/P1B/SDI2/SDA2/AN8			
		RB2	I/O	TTL	Digital I/O.
		INT2	I	ST	External interrupt 2.
		CTED1	I	ST	CTMU Edge 1 input.
		P1B	O	CMOS	Enhanced CCP1 PWM output.
		SDI2	I	ST	SPI data in (MSSP).
		SDA2	I/O	ST	I^2C data I/O (MSSP).
		AN8	I	Analog	Analog input 8.
24	21	RB3/CTED2/P2A/CCP2/SDO2/C12IN2-/AN9			
		RB3	I/O	TTL	Digital I/O.
		CTED2	I	ST	CTMU Edge 2 input.
		P2A	O	CMOS	Enhanced CCP2 PWM output.
		CCP2**(2)**	I/O	ST	Capture 2 input/Compare 2 output/PWM 2 output.
		SDO2	O	—	SPI data out (MSSP).
		C12IN2-	I	Analog	Comparators C1 and C2 inverting input.
		AN9	I	Analog	Analog input 9.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-2: PIC18(L)F2XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Number		Pin Name	Pin Type	Buffer Type	Description
PDIP, SOIC	QFN, UQFN				
25	22	RB4/IOC0/P1D/T5G/AN11			
		RB4	I/O	TTL	Digital I/O.
		IOC0	I	TTL	Interrupt-on-change pin.
		P1D	O	CMOS	Enhanced CCP1 PWM output.
		T5G	I	ST	Timer5 external clock gate input.
		AN11	I	Analog	Analog input 11.
26	23	RB5/IOC1/P2B/P3A/CCP3/T3CKI/T1G/AN13			
		RB5	I/O	TTL	Digital I/O.
		IOC1	I	TTL	Interrupt-on-change pin.
		P2B(1)	O	CMOS	Enhanced CCP2 PWM output.
		P3A(1)	O	CMOS	Enhanced CCP3 PWM output.
		CCP3(1)	I/O	ST	Capture 3 input/Compare 3 output/PWM 3 output.
		T3CKI(2)	I	ST	Timer3 clock input.
		T1G	I	ST	Timer1 external clock gate input.
		AN13	I	Analog	Analog input 13.
27	24	RB6/IOC2/TX2/CK2/PGC			
		RB6	I/O	TTL	Digital I/O.
		IOC2	I	TTL	Interrupt-on-change pin.
		TX2	O	—	EUSART asynchronous transmit.
		CK2	I/O	ST	EUSART synchronous clock (see related RXx/DTx).
		PGC	I/O	ST	In-Circuit Debugger and ICSP™ programming clock pin.
28	25	RB7/IOC3/RX2/DT2/PGD			
		RB7	I/O	TTL	Digital I/O.
		IOC3	I	TTL	Interrupt-on-change pin.
		RX2	I	ST	EUSART asynchronous receive.
		DT2	I/O	ST	EUSART synchronous data (see related TXx/CKx).
		PGD	I/O	ST	In-Circuit Debugger and ICSP™ programming data pin.
11	8	RC0/P2B/T3CKI/T3G/T1CKI/SOSCO			
		RC0	I/O	ST	Digital I/O.
		P2B(2)	O	CMOS	Enhanced CCP1 PWM output.
		T3CKI(1)	I	ST	Timer3 clock input.
		T3G	I	ST	Timer3 external clock gate input.
		T1CKI	I	ST	Timer1 clock input.
		SOSCO	O	—	Secondary oscillator output.
12	9	RC1/P2A/CCP2/SOSCI			
		RC1	I/O	ST	Digital I/O.
		P2A	O	CMOS	Enhanced CCP2 PWM output.
		CCP2(1)	I/O	ST	Capture 2 input/Compare 2 output/PWM 2 output.
		SOSCI	I	Analog	Secondary oscillator input.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-2: PIC18(L)F2XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Number		Pin Name	Pin Type	Buffer Type	Description
PDIP, SOIC	QFN, UQFN				
13	10	RC2/CTPLS/P1A/CCP1/T5CKI/AN14			
		RC2	I/O	ST	Digital I/O.
		CTPLS	O	—	CTMU pulse generator output.
		P1A	O	CMOS	Enhanced CCP1 PWM output.
		CCP1	I/O	ST	Capture 1 input/Compare 1 output/PWM 1 output.
		T5CKI	I	ST	Timer5 clock input.
		AN14	I	Analog	Analog input 14.
14	11	RC3/SCK1/SCL1/AN15			
		RC3	I/O	ST	Digital I/O.
		SCK1	I/O	ST	Synchronous serial clock input/output for SPI mode (MSSP).
		SCL1	I/O	ST	Synchronous serial clock input/output for I^2C mode (MSSP).
		AN15	I	Analog	Analog input 15.
15	12	RC4/SDI1/SDA1/AN16			
		RC4	I/O	ST	Digital I/O.
		SDI1	I	ST	SPI data in (MSSP).
		SDA1	I/O	ST	I^2C data I/O (MSSP).
		AN16	I	Analog	Analog input 16.
16	13	RC5/SDO1/AN17			
		RC5	I/O	ST	Digital I/O.
		SDO1	O	—	SPI data out (MSSP).
		AN17	I	Analog	Analog input 17.
17	14	RC6/P3A/CCP3/TX1/CK1/AN18			
		RC6	I/O	ST	Digital I/O.
		P3A(2)	O	CMOS	Enhanced CCP3 PWM output.
		CCP3(2)	I/O	ST	Capture 3 input/Compare 3 output/PWM 3 output.
		TX1	O	—	EUSART asynchronous transmit.
		CK1	I/O	ST	EUSART synchronous clock (see related RXx/DTx).
		AN18	I	Analog	Analog input 18.
18	15	RC7/P3B/RX1/DT1/AN19			
		RC7	I/O	ST	Digital I/O.
		P3B	O	CMOS	Enhanced CCP3 PWM output.
		RX1	I	ST	EUSART asynchronous receive.
		DT1	I/O	ST	EUSART synchronous data (see related TXx/CKx).
		AN19	I	Analog	Analog input 19.
1	26	RE3/VPP/$\overline{MCLR}$			
		RE3	I	ST	Digital input.
		VPP	P		Programming voltage input.
		$\overline{MCLR}$	I	ST	Active-Low Master Clear (device Reset) input.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-2: PIC18(L)F2XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Number		Pin Name	Pin Type	Buffer Type	Description
PDIP, SOIC	QFN, UQFN				
20	17	VDD	P	—	Positive supply for logic and I/O pins.
8, 19	5, 16	VSS	P	—	Ground reference for logic and I/O pins.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-3: PIC18(L)F4XK22 PINOUT I/O DESCRIPTIONS

Pin Number				Pin Name	Pin Type	Buffer Type	Description
PDIP	TQFP	QFN	UQFN				
2	19	19	17	RA0/C12IN0-/AN0			
				RA0	I/O	TTL	Digital I/O.
				C12IN0-	I	Analog	Comparators C1 and C2 inverting input.
				AN0	I	Analog	Analog input 0.
3	20	20	18	RA1/C12IN1-/AN1			
				RA1	I/O	TTL	Digital I/O.
				C12IN1-	I	Analog	Comparators C1 and C2 inverting input.
				AN1	I	Analog	Analog input 1.
4	21	21	19	RA2/C2IN+/AN2/DACOUT/VREF-			
				RA2	I/O	TTL	Digital I/O.
				C2IN+	I	Analog	Comparator C2 non-inverting input.
				AN2	I	Analog	Analog input 2.
				DACOUT	O	Analog	DAC Reference output.
				VREF-	I	Analog	A/D reference voltage (low) input.
5	22	22	20	RA3/C1IN+/AN3/VREF+			
				RA3	I/O	TTL	Digital I/O.
				C1IN+	I	Analog	Comparator C1 non-inverting input.
				AN3	I	Analog	Analog input 3.
				VREF+	I	Analog	A/D reference voltage (high) input.
6	23	23	21	RA4/C1OUT/SRQ/T0CKI			
				RA4	I/O	ST	Digital I/O.
				C1OUT	O	CMOS	Comparator C1 output.
				SRQ	O	TTL	SR latch Q output.
				T0CKI	I	ST	Timer0 external clock input.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-3: PIC18(L)F4XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Number				Pin Name	Pin Type	Buffer Type	Description
PDIP	TQFP	QFN	UQFN				
7	24	24	22	RA5/C2OUT/SRNQ/$\overline{SS1}$/HLVDIN/AN4			
				RA5	I/O	TTL	Digital I/O.
				C2OUT	O	CMOS	Comparator C2 output.
				SRNQ	O	TTL	SR latch $\overline{Q}$ output.
				$\overline{SS1}$	I	TTL	SPI slave select input (MSSP1).
				HLVDIN	I	Analog	High/Low-Voltage Detect input.
				AN4	I	Analog	Analog input 4.
14	31	33	29	RA6/CLKO/OSC2			
				RA6	I/O	TTL	Digital I/O.
				CLKO	O	—	In RC mode, OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
				OSC2	O	—	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
13	30	32	28	RA7/CLKI/OSC1			
				RA7	I/O	TTL	Digital I/O.
				CLKI	I	CMOS	External clock source input. Always associated with pin function OSC1.
				OSC1	I	ST	Oscillator crystal input or external clock source input ST buffer when configured in RC mode; CMOS otherwise.
33	8	9	8	RB0/INT0/FLT0/SRI/AN12			
				RB0	I/O	TTL	Digital I/O.
				INT0	I	ST	External interrupt 0.
				FLT0	I	ST	PWM Fault input for ECCP Auto-Shutdown.
				SRI	I	ST	SR latch input.
				AN12	I	Analog	Analog input 12.
34	9	10	9	RB1/INT1/C12IN3-/AN10			
				RB1	I/O	TTL	Digital I/O.
				INT1	I	ST	External interrupt 1.
				C12IN3-	I	Analog	Comparators C1 and C2 inverting input.
				AN10	I	Analog	Analog input 10.
35	10	11	10	RB2/INT2/CTED1/AN8			
				RB2	I/O	TTL	Digital I/O.
				INT2	I	ST	External interrupt 2.
				CTED1	I	ST	CTMU Edge 1 input.
				AN8	I	Analog	Analog input 8.
36	11	12	11	RB3/CTED2/P2A/CCP2/C12IN2-/AN9			
				RB3	I/O	TTL	Digital I/O.
				CTED2	I	ST	CTMU Edge 2 input.
				P2A(2)	O	CMOS	Enhanced CCP2 PWM output.
				CCP2(2)	I/O	ST	Capture 2 input/Compare 2 output/PWM 2 output.
				C12IN2-	I	Analog	Comparators C1 and C2 inverting input.
				AN9	I	Analog	Analog input 9.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-3: PIC18(L)F4XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Number				Pin Name	Pin Type	Buffer Type	Description
PDIP	TQFP	QFN	UQFN				
37	14	14	12	RB4/IOC0/T5G/AN11			
				RB4	I/O	TTL	Digital I/O.
				IOC0	I	TTL	Interrupt-on-change pin.
				T5G	I	ST	Timer5 external clock gate input.
				AN11	I	Analog	Analog input 11.
38	15	15	13	RB5/IOC1/P3A/CCP3/T3CKI/T1G/AN13			
				RB5	I/O	TTL	Digital I/O.
				IOC1	I	TTL	Interrupt-on-change pin.
				P3A(1)	O	CMOS	Enhanced CCP3 PWM output.
				CCP3(1)	I/O	ST	Capture 3 input/Compare 3 output/PWM 3 output.
				T3CKI(2)	I	ST	Timer3 clock input.
				T1G	I	ST	Timer1 external clock gate input.
				AN13	I	Analog	Analog input 13.
39	16	16	14	RB6/IOC2/PGC			
				RB6	I/O	TTL	Digital I/O.
				IOC2	I	TTL	Interrupt-on-change pin.
				PGC	I/O	ST	In-Circuit Debugger and ICSP™ programming clock pin.
40	17	17	15	RB7/IOC3/PGD			
				RB7	I/O	TTL	Digital I/O.
				IOC3	I	TTL	Interrupt-on-change pin.
				PGD	I/O	ST	In-Circuit Debugger and ICSP™ programming data pin.
15	32	34	30	RC0/P2B/T3CKI/T3G/T1CKI/SOSCO			
				RC0	I/O	ST	Digital I/O.
				P2B(2)	O	CMOS	Enhanced CCP1 PWM output.
				T3CKI(1)	I	ST	Timer3 clock input.
				T3G	I	ST	Timer3 external clock gate input.
				T1CKI	I	ST	Timer1 clock input.
				SOSCO	O	—	Secondary oscillator output.
16	35	35	31	RC1/P2A/CCP2/SOSCI			
				RC1	I/O	ST	Digital I/O.
				P2A(1)	O	CMOS	Enhanced CCP2 PWM output.
				CCP2(1)	I/O	ST	Capture 2 input/Compare 2 output/PWM 2 output.
				SOSCI	I	Analog	Secondary oscillator input.
17	36	36	32	RC2/CTPLS/P1A/CCP1/T5CKI/AN14			
				RC2	I/O	ST	Digital I/O.
				CTPLS	O	—	CTMU pulse generator output.
				P1A	O	CMOS	Enhanced CCP1 PWM output.
				CCP1	I/O	ST	Capture 1 input/Compare 1 output/PWM 1 output.
				T5CKI	I	ST	Timer5 clock input.
				AN14	I	Analog	Analog input 14.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-3: PIC18(L)F4XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Number				Pin Name	Pin Type	Buffer Type	Description
PDIP	TQFP	QFN	UQFN				
18	37	37	33	RC3/SCK1/SCL1/AN15			
				RC3	I/O	ST	Digital I/O.
				SCK1	I/O	ST	Synchronous serial clock input/output for SPI mode (MSSP).
				SCL1	I/O	ST	Synchronous serial clock input/output for I^2C mode (MSSP).
				AN15	I	Analog	Analog input 15.
23	42	42	38	RC4/SDI1/SDA1/AN16			
				RC4	I/O	ST	Digital I/O.
				SDI1	I	ST	SPI data in (MSSP).
				SDA1	I/O	ST	I^2C data I/O (MSSP).
				AN16	I	Analog	Analog input 16.
24	43	43	39	RC5/SDO1/AN17			
				RC5	I/O	ST	Digital I/O.
				SDO1	O	—	SPI data out (MSSP).
				AN17	I	Analog	Analog input 17.
25	44	44	40	RC6/TX1/CK1/AN18			
				RC6	I/O	ST	Digital I/O.
				TX1	O	—	EUSART asynchronous transmit.
				CK1	I/O	ST	EUSART synchronous clock (see related RXx/DTx).
				AN18	I	Analog	Analog input 18.
26	1	1	1	RC7/RX1/DT1/AN19			
				RC7	I/O	ST	Digital I/O.
				RX1	I	ST	EUSART asynchronous receive.
				DT1	I/O	ST	EUSART synchronous data (see related TXx/CKx).
				AN19	I	Analog	Analog input 19.
19	38	38	34	RD0/SCK2/SCL2/AN20			
				RD0	I/O	ST	Digital I/O.
				SCK2	I/O	ST	Synchronous serial clock input/output for SPI mode (MSSP).
				SCL2	I/O	ST	Synchronous serial clock input/output for I^2C mode (MSSP).
				AN20	I	Analog	Analog input 20.
20	39	39	35	RD1/CCP4/SDI2/SDA2/AN21			
				RD1	I/O	ST	Digital I/O.
				CCP4	I/O	ST	Capture 4 input/Compare 4 output/PWM 4 output.
				SDI2	I	ST	SPI data in (MSSP).
				SDA2	I/O	ST	I^2C data I/O (MSSP).
				AN21	I	Analog	Analog input 21.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-3: PIC18(L)F4XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Number				Pin Name	Pin Type	Buffer Type	Description
PDIP	TQFP	QFN	UQFN				
21	40	40	36	RD2/P2B/AN22			
				RD2	I/O	ST	Digital I/O
				P2B(1)	O	CMOS	Enhanced CCP2 PWM output.
				AN22	I	Analog	Analog input 22.
22	41	41	37	RD3/P2C/$\overline{SS2}$/AN23			
				RD3	I/O	ST	Digital I/O.
				P2C	O	CMOS	Enhanced CCP2 PWM output.
				$\overline{SS2}$	I	TTL	SPI slave select input (MSSP).
				AN23	I	Analog	Analog input 23.
27	2	2	2	RD4/P2D/SDO2/AN24			
				RD4	I/O	ST	Digital I/O.
				P2D	O	CMOS	Enhanced CCP2 PWM output.
				SDO2	O	—	SPI data out (MSSP).
				AN24	I	Analog	Analog input 24.
28	3	3	3	RD5/P1B/AN25			
				RD5	I/O	ST	Digital I/O.
				P1B	O	CMOS	Enhanced CCP1 PWM output.
				AN25	I	Analog	Analog input 25.
29	4	4	4	RD6/P1C/TX2/CK2/AN26			
				RD6	I/O	ST	Digital I/O.
				P1C	O	CMOS	Enhanced CCP1 PWM output.
				TX2	O	—	EUSART asynchronous transmit.
				CK2	I/O	ST	EUSART synchronous clock (see related RXx/DTx).
				AN26	I	Analog	Analog input 26.
30	5	5	5	RD7/P1D/RX2/DT2/AN27			
				RD7	I/O	ST	Digital I/O.
				P1D	O	CMOS	Enhanced CCP1 PWM output.
				RX2	I	ST	EUSART asynchronous receive.
				DT2	I/O	ST	EUSART synchronous data (see related TXx/CKx).
				AN27	I	Analog	Analog input 27.
8	25	25	23	RE0/P3A/CCP3/AN5			
				RE0	I/O	ST	Digital I/O.
				P3A(2)	O	CMOS	Enhanced CCP3 PWM output.
				CCP3(2)	I/O	ST	Capture 3 input/Compare 3 output/PWM 3 output.
				AN5	I	Analog	Analog input 5.
9	26	26	24	RE1/P3B/AN6			
				RE1	I/O	ST	Digital I/O.
				P3B	O	CMOS	Enhanced CCP3 PWM output.
				AN6	I	Analog	Analog input 6.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

TABLE 1-3: PIC18(L)F4XK22 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Number				Pin Name	Pin Type	Buffer Type	Description
PDIP	TQFP	QFN	UQFN				
10	27	27	25	RE2/CCP5/AN7			
				RE2	I/O	ST	Digital I/O.
				CCP5	I/O	ST	Capture 5 input/Compare 5 output/PWM 5 output
				AN7	I	Analog	Analog input 7.
1	18	18	16	RE3/VPP/$\overline{\text{MCLR}}$			
				RE3	I	ST	Digital input.
				VPP	P		Programming voltage input.
				$\overline{\text{MCLR}}$	I	ST	Active-low Master Clear (device Reset) input.
11,32	7, 28	7, 8, 28, 29	7, 26	VDD	P	—	Positive supply for logic and I/O pins.
12,31	6, 29	6,30, 31	6, 27	VSS	P	—	Ground reference for logic and I/O pins.
	12,13, 33,34	13		NC			

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I = Input; O = Output; P = Power.

Note 1: Default pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

2: Alternate pin assignment for P2B, T3CKI, CCP3/P3A and CCP2/P2A when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are clear.

2.0 OSCILLATOR MODULE (WITH FAIL-SAFE CLOCK MONITOR)

2.1 Overview

The oscillator module has a wide variety of clock sources and selection features that allow it to be used in a wide range of applications while maximizing performance and minimizing power consumption. Figure 2-1 illustrates a block diagram of the oscillator module.

Clock sources can be configured from external oscillators, quartz crystal resonators, ceramic resonators and Resistor-Capacitor (RC) circuits. In addition, the system clock source can be configured from one of three internal oscillators, with a choice of speeds selectable via software. Additional clock features include:

- Selectable system clock source between external or internal sources via software.
- Two-Speed Start-up mode, which minimizes latency between external oscillator start-up and code execution.
- Fail-Safe Clock Monitor (FSCM) designed to detect a failure of the external clock source (LP, XT, HS, EC or RC modes) and switch automatically to the internal oscillator.
- Oscillator Start-up Timer (OST) ensures stability of crystal oscillator sources.

The primary clock module can be configured to provide one of six clock sources as the primary clock.

1. RC External Resistor/Capacitor
2. LP Low-Power Crystal
3. XT Crystal/Resonator
4. INTOSC Internal Oscillator
5. HS High-Speed Crystal/Resonator
6. EC External Clock

The HS and EC oscillator circuits can be optimized for power consumption and oscillator speed using settings in FOSC<3:0>. Additional FOSC<3:0> selections enable RA6 to be used as I/O or CLKO (FOSC/4) for RC, EC and INTOSC Oscillator modes.

Primary Clock modes are selectable by the FOSC<3:0> bits of the CONFIG1H Configuration register. The primary clock operation is further defined by these Configuration and register bits:

1. PRICLKEN (CONFIG1H<5>)
2. PRISD (OSCCON2<2>)
3. PLLCFG (CONFIG1H<4>)
4. PLLEN (OSCTUNE<6>)
5. HFOFST (CONFIG3H<3>)
6. IRCF<2:0> (OSCCON<6:4>)
7. MFIOSEL (OSCCON2<4>)
8. INTSRC (OSCTUNE<7>)

The HFINTOSC, MFINTOSC and LFINTOSC are factory calibrated high, medium and low-frequency oscillators, respectively, which are used as the internal clock sources.